



II SEMESTER M.TECH (T & M) END SEMESTER EXAMINATIONS,

APRIL 2019

SUBJECT: MICROSTRUCTURE & SURFACE CHARACTERIZATION [MME 5206]

REVISED CREDIT SYSTEM

Time: 3 Hours

MAX. MARKS: 50

Instructions to Candidates:

- ❖ Answer **ALL** the questions.
- ❖ Missing data may be suitably assumed.

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| 1A. | Discuss the steps involved in sample preparations for OM and SEM analysis | 5 |
| 1B. | Define (i) grains; (ii) grain boundaries & (iii) microstructure | 3 |
| 1C. | Discuss why metallography is important in tribology? | 2 |
| 2A. | Name the major parts of an optical microscope and state their functions. | 3 |
| 2B. | Discuss the information output from optical microscope and how it is usefulness in materials characterization? | 5 |
| 2C. | What is meant by depth of field? What is the depth of focus? | 2 |
| 3A. | Why does the column of an electron microscope need to be evacuated? | 2 |
| 3B. | Discuss the out puts of SEM-EDS and how it is usefulness in understanding the materials characterization? | 6 |
| 3C. | How do you analyze the SEM image? | 2 |
| 4A. | Field emission microscope: Describe the principle! Which are the advantages/disadvantages of this method? | 4 |
| 4B. | Explain the electron beam interaction with thin specimen (schematics). | 4 |
| 4C. | Which are the advantages/ disadvantages of transmission electron microscopy (TEM) in comparison to scanning electron microscopy (SEM)? | 2 |
| 5A. | How X-Rays are produced? Explain with schematics | 3 |
| 5B. | Discuss the materials/surface characterization required to be carried out on any coated samples. Provide justification for each analysis. | 5 |
| 5C. | What are the differences between XRD and XPS? | 2 |